

800mA LOW DROPOUT POSITIVE ADJUSTABLE REGULATOR

PRELIMINARY DATASHEET

FEATURES

- Guaranteed < 1.3V Dropout at Full Load Current
- Fast Transient Response
- 1% Voltage Reference Initial Accuracy
- Built-in Thermal Shutdown
- Available in SOT-223, D-Pak, Ultra Thin-Pak and 8-pin SOIC Surface-mount Packages

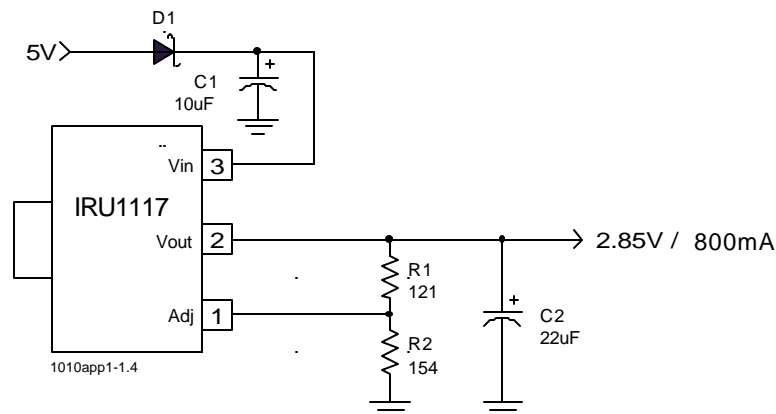
APPLICATIONS

- VGA & Sound Card Applications
- Low Voltage High Speed Termination Applications
- Standard 3.3V Chipset and Logic Applications

DESCRIPTION

The IRU1117 is a low dropout, three-terminal adjustable regulator with minimum of 800mA output current capability. This product is specifically designed to provide well regulated supply for low voltage IC applications such as high speed bus termination and low current 3.3V logic supply. The IRU1117 is also well suited for other applications such as VGA and sound cards. The IRU1117 is guaranteed to have <1.3V dropout at full load current making it ideal to provide well regulated outputs of 2.5V to 3.6V with 4.75V to 7V input supply.

TYPICAL APPLICATION



Typical application of IRU1117 in a 5V to 2.85V SCSI termination regulator

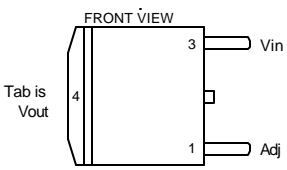
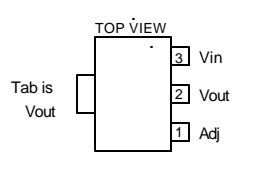
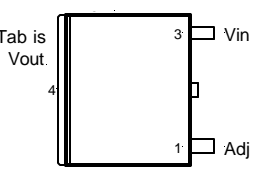
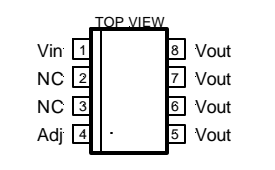
PACKAGE ORDER INFORMATION

Tj (°C)	2-PIN PLASTIC TO-252 (D)	3-PIN PLASTIC SOT-223 (Y)	2-PIN PLASTIC Ultra Thin-Pak (P)	8-PIN PLASTIC SOIC (S)
0 TO 150	IRU1117CD	IRU1117CY	IRU1117CP	IRU1117CS

ABSOLUTE MAXIMUM RATINGS

Input Voltage (V_{in})	7V
Power Dissipation	Internally Limited
Storage Temperature Range	-65°C TO 150°C
Operating Junction Temperature Range	0°C TO 150°C

PACKAGE INFORMATION

2-PIN PLASTIC TO-252 (D)	3-PIN PLASTIC SO-223 (Y)	2-PIN ULTRA THIN-PAK (P)	8-PIN PLASTIC SOIC (S)
 <p>$\theta_{JA}=70^{\circ}\text{C/W}$ for 0.5" Sq pad</p>	 <p>$\theta_{JA}=90^{\circ}\text{C/W}$ for 0.4" Sq pad</p>	 <p>$\theta_{JA}=70^{\circ}\text{C/W}$ for 0.5" Sq pad</p>	 <p>$\theta_{JA}=55^{\circ}\text{C/W}$ for 1" Sq pad</p>

ELECTRICAL SPECIFICATIONS

Unless otherwise specified, these specifications apply over, $C_{in}=1\mu\text{F}$, $C_{out}=10\mu\text{F}$, and $T_j=0$ to 150°C . Typical values refer to $T_j=25^{\circ}\text{C}$.

PARAMETER	SYM	TEST CONDITION	MIN	TYP	MAX	UNITS
Reference Voltage	V_{REF}	$I_o=10\text{mA}$, $T_j=25^{\circ}\text{C}$, $(V_{in}-V_o)=1.5\text{V}$ $I_o=10\text{mA}$, $(V_{in}-V_o)=1.5\text{V}$	1.243 1.237	1.250 1.250	1.257 1.263	V
Line Regulation		$I_o=10\text{mA}$, $1.3\text{V}<(V_{in}-V_o)<7\text{V}$			0.2	%
Load Regulation (note 1)		$V_{in}=3.3\text{V}$, $V_{adj}=0$, $10\text{mA}<I_o<800\text{mA}$			0.4	%
Dropout Voltage (note 2)	ΔV_o	Note 2, $I_o=800\text{mA}$		1.1	1.3	V
Current Limit		$V_{in}=3.3\text{V}$, $dV_o=100\text{mV}$	1.1			A
Minimum Load Current (note 3)		$V_{in}=3.3\text{V}$, $V_{adj}=0\text{V}$		5	10	mA
Thermal Regulation		30mS Pulse, $V_{in}-V_o=3\text{V}$, $I_o=800\text{mA}$		0.01	0.02	%/W
Ripple Rejection		$f=120\text{Hz}$, $C_o=25\mu\text{F}$ Tan $I_o=0.5\text{A}$, $V_{in}-V_o=3\text{V}$	60	70		dB
Adjust Pin Current	I_{ADJ}	$I_o=10\text{mA}$, $V_{in}-V_o=1.5\text{V}$, $T_j=25$ $I_o=10\text{mA}$, $V_{in}-V_o=1.5\text{V}$		55	120	μA
Adjust Pin Current Change		$I_o=10\text{mA}$, $V_{in}-V_o=1.5\text{V}$, $T_j=25$		0.2	5	μA
Temperature Stability		$V_{in}=3.3\text{V}$, $V_{adj}=0\text{V}$, $I_o=10\text{mA}$		0.5		%
Long Term Stability		$T_j=125^{\circ}\text{C}$, 1000 Hrs		0.3	1	%
RMS Output Noise		$T_j=25^{\circ}\text{C}$ 10hz< f <10khz		0.003		% V_o

Note 1: Low duty cycle pulse testing with Kelvin connections are required in order to maintain accurate data.

Note 2: Dropout voltage is defined as the minimum differential voltage between V_{in} and V_{out} required to maintain regulation at V_{out} . It is measured when the output voltage drops 1% below its nominal value.

Note 3: Minimum load current is defined as the minimum current required at the output in order for the output voltage to maintain regulation. Typically, the resistor dividers are selected such that it automatically maintains this current.

PIN DESCRIPTIONS

PIN #	PIN SYMBOL	PIN DESCRIPTION
1	Adj	A resistor divider from this pin to the Vout pin and ground sets the output voltage.
2	Vout	The output of the regulator. A minimum of 10 μ F capacitor must be connected from this pin to ground to insure stability.
3	Vin	The input pin of the regulator. Typically a large storage capacitor is connected from this pin to ground to insure that the input voltage does not sag below the minimum dropout voltage during the load transient response. This pin must always be 1.3V higher than Vout in order for the device to regulate properly.

BLOCK DIAGRAM

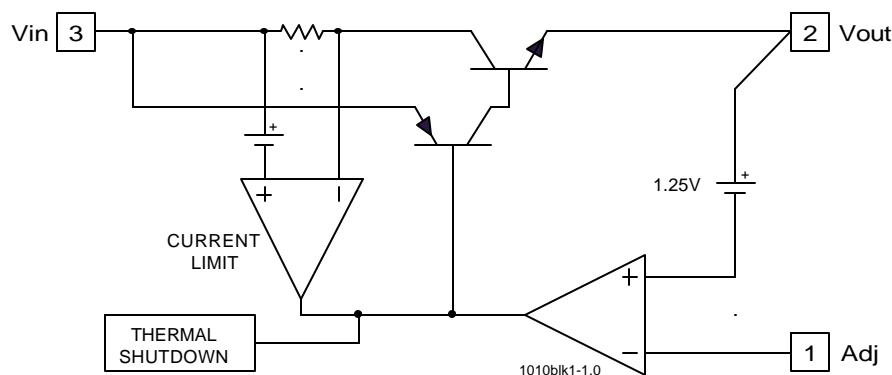


Figure 1 - Simplified block diagram of the IRU1117

APPLICATION INFORMATION

Introduction

The IRU1117 adjustable Low Dropout (LDO) regulator is a three-terminal device which can easily be programmed with the addition of two external resistors to any voltages within the range of 1.25 to 5.5V. This regulator, unlike the first generation of the 3T regulators such as LM1117 that required 3V differential between the input and the regulated output, only needs 1.3V differential to maintain output regulation. This is a key requirement for today's low voltage IC applications that typically need 3.3V supply and are often generated from the 5V supply. Other applications such as high speed memory ter-

mination need to switch the load current from zero to full load in tens of nanoseconds at their pins, which translates to an approximately 300 to 500nS current step at the regulator. In addition, the output voltage tolerances are sometimes tight and they include the transient response as part of the specification.

The IRU1117 is specifically designed to meet the fast current transient needs as well as providing an accurate initial voltage, reducing the overall system cost with the need for fewer output capacitors.

IRU1117

Output Voltage Setting

The IRU1117 can be programmed to any voltages in the range of 1.25V to 5.5V with the addition of R1 and R2 external resistors according to the following formula:

$$V_{OUT} = V_{REF} \left(1 + \frac{R_2}{R_1} \right) + I_{ADJ} \times R_2$$

Where : $V_{REF} = 1.25V$ Typically

$I_{ADJ} = 50 \text{ uA}$ Typically

R1 & R2 as shown in figure 2

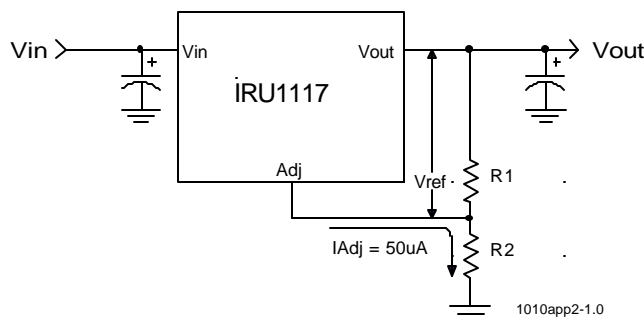


Figure 2 - Typical application of the IRU1117 for programming the output voltage

The IRU1117 keeps a constant 1.25V between the output pin and the adjust pin. By placing a resistor R1 across these two pins a constant current flows through R1, adding to the I_{adj} current and into the R2 resistor producing a voltage equal to the $(1.25/R1) \times R2 + I_{adj} \times R2$ which will be added to the 1.25V to set the output voltage. This is summarized in the above equation. Since the minimum load current requirement of the IRU1117 is 10mA, R1 is typically selected to be 121 Ω resistor so that it automatically satisfies the minimum current requirement. Notice that since I_{adj} is typically in the range of 50 μ A it only adds a small error to the output voltage and should only be considered when a very precise output voltage setting is required. For example, in a typical 3.3V application where $R1=121\Omega$ and $R2=200\Omega$ the error due to I_{adj} is only 0.3% of the nominal set point.

Load Regulation

Since the IRU1117 is only a three-terminal device, it is not possible to provide true remote sensing of the output voltage at the load. Figure 3 shows that the best load

regulation is achieved when the bottom side of R2 is connected to the load and the top side of R1 resistor is connected directly to the case or the Vout pin of the regulator and not to the load. In fact, if R1 is connected to the load side, the effective resistance between the regulator and the load is gained up by the factor of $(1+R2/R1)$, or the effective resistance will be, $R_{p(eff)}=R_p \times (1+R2/R1)$. It is important to note that for high current applications, this can represent a significant percentage of the overall load regulation and one must keep the path from the regulator to the load as short as possible to minimize this effect.

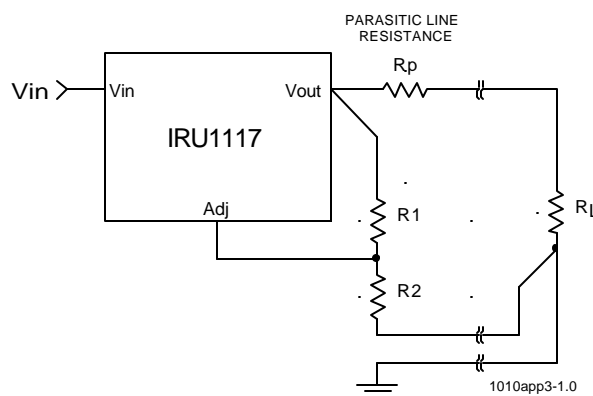


Figure 3 - Schematic showing connection for best load regulation

Stability

The IRU1117 requires the use of an output capacitor as part of the frequency compensation in order to make the regulator stable. Typical designs for microprocessor applications use standard electrolytic capacitors with a typical ESR in the range of 50 to 100m Ω and an output capacitance of 500 to 1000 μ F. Fortunately as the capacitance increases, the ESR decreases resulting in a fixed RC time constant. The IRU1117 takes advantage of this phenomena in making the overall regulator loop stable. For most applications a minimum of 100 μ F aluminum electrolytic capacitor such as Sanyo MVGX series, Panasonic FA series as well as the Nichicon PL series insures both stability and good transient response.

Thermal Design

The IRU1117 incorporates an internal thermal shutdown that protects the device when the junction temperature exceeds the maximum allowable junction temperature. Although this device can operate with junction temperatures in the range of 150°C, it is recommended that the selected heat sink be chosen such that during maximum continuous load operation the junction temperature is kept below this number. The example below for a SCSI terminator application shows the steps in selecting the proper regulator in a surface-mount package. (See IRU1015 for non-surface-mount packages) Assuming the following specifications:

$$\begin{aligned} V_{IN} &= 5V \\ V_F &= 0.5V \\ V_O &= 2.85V \\ I_{OUTMAX} &= 0.8A \\ T_A &= 35^\circ C \end{aligned}$$

Where; V_F is the forward voltage drop of the D1 diode as shown in Figure 4.

The steps for selecting the right package with proper board area for heatsinking to keep the junction temperature below 135°C is given as:

- 1) Calculate the maximum power dissipation using:

$$\begin{aligned} P_D &= I_{OUT} \times (V_{IN} - V_F - V_{OUT}) \\ P_D &= 0.8 \times (5 - 0.5 - 2.85) = 1.32 \text{ W} \end{aligned}$$

- 2) Calculate the maximum θ_{JA} allowed for our example:

$$\begin{aligned} \theta_{JAMAX} &= \frac{T_J - T_A}{P_D} \\ \theta_{JAMAX} &= \frac{135 - 35}{1.32} = 75.6^\circ C / W \end{aligned}$$

- 3) Select a package from the datasheet with lower θ_{JA} than the one calculated in the previous step.

Selecting TO-252 (D-Pak) with at least 0.5" square of 0.062" FR4 board using 1 oz. copper has 70° C/W which is lower than the calculated number.

To set the output DC voltage, we need to select R1 and R2:

- 4) Assuming $R1 = 121 \Omega, 1\%$

$$R_2 = \left(\frac{V_{OUT}}{V_{REF}} - 1 \right) \times 121 = \left(\frac{2.85}{1.25} - 1 \right) \times 121 = 154.8 \Omega$$

Select $R2 = 154 \Omega, 1\%$

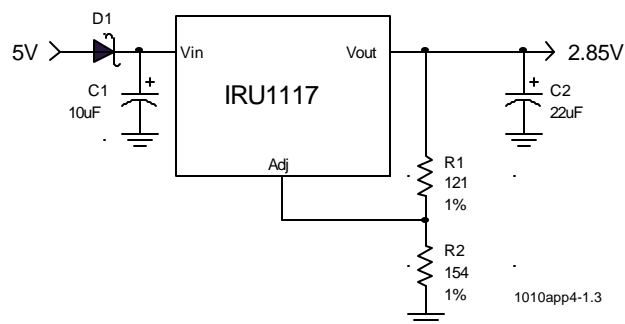


Figure 4 - Final Schematic for half of the GTL+ termination regulator

Layout Consideration

The output capacitors must be located as close to the Vout terminal of the device as possible. It is recommended to use a section of a layer of the PC board as a plane to connect the Vout pin to the output capacitors to prevent any high frequency oscillation that may result due to excessive trace inductance.

